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2SB1400

Silicon PNP Epitaxial

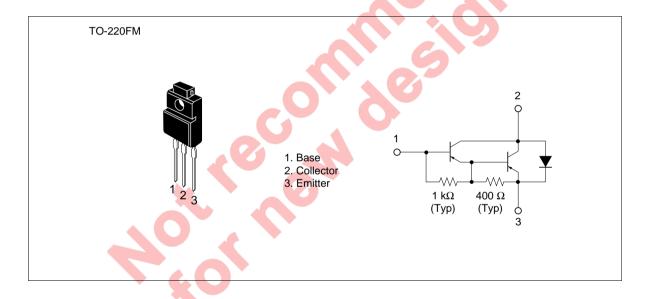


ADE-208-874 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier

Outline



2SB1400

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit	
Collector to base voltage	V_{CBO}	V _{CBO} -120		
Collector to emitter voltage	V _{CEO} -120		V	
Emitter to base voltage	V_{EBO}	-7	V	
Collector current	I _c	-6	Α	
Collector peak current	I _{C(peak)}	-10	Α	
Collector power dissipation	P _c	2	W	
	P _c *1	25		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

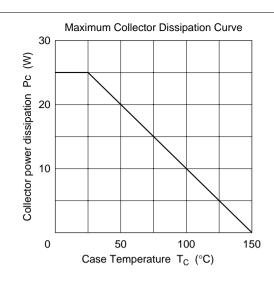
Note: 1. Value at $T_c = 25^{\circ}C$.

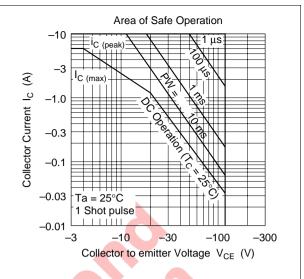
Electrical Characteristics ($Ta = 25^{\circ}C$)

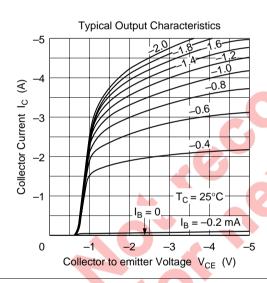
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-120		N	V	$I_{\rm C} = -0.1 \text{ mA}, I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-120	_	5	V	$I_{\rm C} = -25$ mA, $R_{\rm BE} = \infty$
Emitter to base breakdown voltage	V _{(BR)EBO}	-7	1	_	V	$I_{\rm E} = -50 \text{ mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	- (2	<u>/</u>	-10	μΑ	$V_{CB} = -100 \text{ V}, I_{E} = 0$
	CEO		_	-10	_	$V_{CE} = -100 \text{ V}, R_{BE} = \infty$
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = -3 \text{ V}, I_{C} = -3 \text{ A}^{*1}$
Collector to emitter saturation	V _{CE(sat)1}	_	_	-1.5	V	$I_{\rm C} = -3 \text{ A}, I_{\rm B} = -6 \text{ mA}^{*1}$
voltage	V _{CE(sat)2}	_	_	-3.0		$I_{\rm C} = -6$ A, $I_{\rm B} = -60$ mA* ¹
Base to emitter saturation	V _{BE(sat)1}	_	_	-2.0	V	$I_{\rm C} = -3 \text{ A}, I_{\rm B} = -6 \text{ mA}^{*1}$
voltage	V _{BE(sat)2}	_	_	-3.5	=	$I_{\rm C} = -6 \text{ A}, I_{\rm B} = -60 \text{ mA}^{*1}$

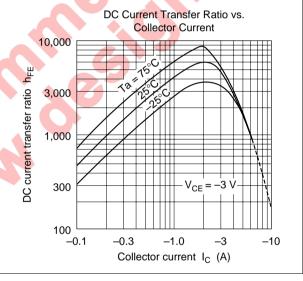
Note: 1. Pulse test.

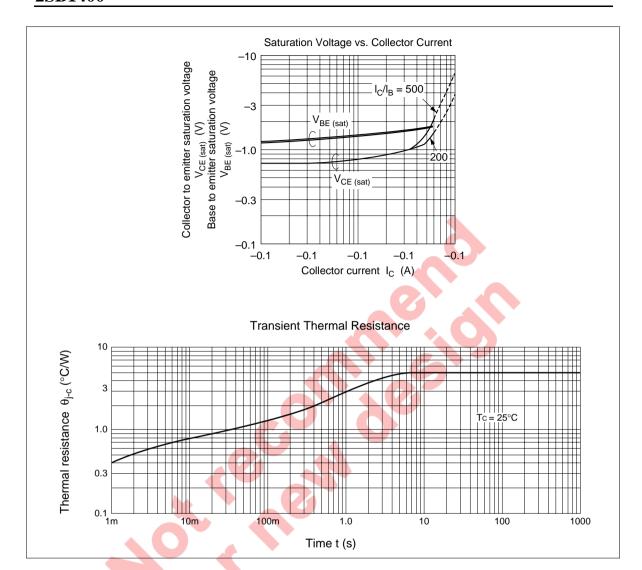
See switching characteristic curve of 2SB727(K).











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